

STN	Vysokofrekvenčné indukčné súčiastky Neelektrické charakteristiky a metódy merania Časť 2: Skúšobné metódy na neelektrické charakteristiky	STN EN IEC 62025-2 34 5851
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High frequency inductive components - Non-electrical characteristics and measuring methods - Part 2: Test methods for non-electrical characteristics

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 03/20

Obsahuje: EN IEC 62025-2:2019, IEC 62025-2:2019

Oznámením tejto normy sa od 25.10.2022 ruší
STN EN 62025-2 (34 5851) z augusta 2005

130646

EUROPEAN STANDARD

EN IEC 62025-2

NORME EUROPÉENNE

EUROPÄISCHE NORM

November 2019

ICS 29.100.10

Supersedes EN 62025-2:2005 and all of its amendments
and corrigenda (if any)

English Version

High frequency inductive components - Non-electrical
characteristics and measuring methods - Part 2: Test methods
for non-electrical characteristics
(IEC 62025-2:2019)

Composants inductifs à haute fréquence - Caractéristiques
non électriques et méthodes de mesure - Partie 2:
Méthodes d'essai pour caractéristiques non électriques
(IEC 62025-2:2019)

Induktive Hochfrequenzbauelemente - Nichtelektrische
Eigenschaften und Messmethoden - Teil 2: Messverfahren
für nichtelektrische Eigenschaften
(IEC 62025-2:2019)

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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 62025-2:2019 (E)**European foreword**

The text of document 51/1273/CDV, future edition 2 of IEC 62025-2, prepared by IEC/TC 51 "Magnetic components, ferrite and magnetic powder materials" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62025-2:2019.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2020-07-25
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2022-10-25

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Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60068-1	-	Environmental testing - Part 1: General and guidance	EN 60068-1	-
IEC 60068-2-6	2007	Environmental testing - Part 2-6: Tests - Test Fc: Vibration (sinusoidal)	EN 60068-2-6	2008
IEC 60068-2-20	-	Environmental testing - Part 2-20: Tests - Test T: Test methods for solderability and resistance to soldering heat of devices with leads	EN 60068-2-20	-
IEC 60068-2-21	2006	Environmental testing - Part 2-21: Tests - Test U: Robustness of terminations and integral mounting devices	EN 60068-2-21	2006
IEC 60068-2-27	-	Environmental testing - Part 2-27: Tests - Test Ea and guidance: Shock	EN 60068-2-27	-
IEC 60068-2-45	1980	Basic environmental testing procedures - Part 2-45: Tests - Test XA and guidance: Immersion in cleaning solvents	EN 60068-2-45	1992
+ A1	1993		+ A1	1993
IEC 60068-2-58	2015	Environmental testing - Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58	2015
+ A1	2017		+ A1	2018
IEC 60068-2-69	-	Environmental testing – Part 2-69: Tests – Test Te/Tc: Solderability testing of electronic components and printed boards by the wetting balance (force measurement) method	EN 60068-2-69	-
IEC 60068-2-77	-	Environmental testing - Part 2-77: Tests - Test 77: Body strength and impact shock	EN 60068-2-77	-

EN IEC 62025-2:2019 (E)

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61188-5-2	-	Printed boards and printed board assemblies - Design and use - Part 5-2: Attachment (land/joint) considerations - Discrete components	EN 61188-5-2	-
IEC 61190-1-2	2014	Attachment materials for electronic assembly - Part 1-2: Requirements for soldering pastes for high-quality interconnects in electronics assembly	EN 61190-1-2	2014
IEC 61190-1-3	-	Attachment materials for electronic assembly - Part 1-3: Requirements for electronic grade solder alloys and fluxed and non-fluxed solid solder for electronic soldering applications	EN IEC 61190-1-3	-
IEC 62211	2017	Inductive components – Reliability management	EN 62211	2017



IEC 62025-2

Edition 2.0 2019-09

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**High frequency inductive components – Non-electrical characteristics and measuring methods –
Part 2: Test methods for non-electrical characteristics**

**Composants inductifs à haute fréquence – Caractéristiques non électriques et méthodes de mesure –
Partie 2: Méthodes d'essai pour caractéristiques non électriques**





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IEC 62025-2

Edition 2.0 2019-09

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**High frequency inductive components – Non-electrical characteristics and measuring methods –
Part 2: Test methods for non-electrical characteristics**

**Composants inductifs à haute fréquence – Caractéristiques non électriques et méthodes de mesure –
Partie 2: Méthodes d'essai pour caractéristiques non électriques**

INTERNATIONAL
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ICS 29.100.10

ISBN 978-2-8322-7375-3

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**HIGH FREQUENCY INDUCTIVE COMPONENTS –
NON-ELECTRICAL CHARACTERISTICS AND MEASURING METHODS –****Part 2: Test methods for non-electrical characteristics**

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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International Standard IEC 62025-2 has been prepared by IEC technical committee 51: Magnetic components, ferrite and magnetic powder materials.

This second edition cancels and replaces the first edition published in 2005. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) revision of Table 5;
- b) revision of normative references.

The text of this standard is based on the following documents:

CDV	Report on voting
51/1273/CDV	51/1301/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62025 series, published under the general title *High frequency inductive components – Non-electrical characteristics and measuring methods*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

HIGH FREQUENCY INDUCTIVE COMPONENTS – NON-ELECTRICAL CHARACTERISTICS AND MEASURING METHODS –

Part 2: Test methods for non-electrical characteristics

1 Scope

This part of IEC 62025 specifies a test method for the non-electrical characteristics of the surface mounted device (SMD) inductors to be used for electronic and telecommunication equipment. The object of this part of this document is to define methods for measuring mechanical performance only. As the reliability performances and specifications relative to non-electrical performances are defined in IEC 62211, detailed measuring methods for mechanical performance of reliability testing are defined in this document.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1, *Environmental testing – Part 1: General and guidance*

IEC 60068-2-6:2007, *Environmental testing – Part 2: Tests – Test Fc: Vibration (sinusoidal)*

IEC 60068-2-20, *Environmental testing – Part 2-20: Tests – Test T: Test methods for solderability and resistance to soldering heat of devices with leads*

IEC 60068-2-21:2006, *Environmental testing – Part 2-21: Tests – Test U: Robustness of terminations and integral mounting devices*

IEC 60068-2-27, *Environmental testing – Part 2-27: Tests – Test Ea and guidance: Shock*

IEC 60068-2-45:1980, *Basic environmental testing procedures – Part 2-45: Tests – Test XA and guidance: Immersion in cleaning solvents*
IEC 60068-2-45:1980/AMD1:1993

IEC 60068-2-58:2015, *Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*
IEC 60068-2-58:2015/AMD1:2017

IEC 60068-2-69, *Environmental testing – Part 2-69: Tests – Test Te/Tc: Solderability testing of electronic components and printed boards by the wetting balance (force measurement) method*

IEC 60068-2-77, *Environmental testing – Part 2-77: Tests – Test 77: Body strength and impact shock*

IEC 61188-5-2, *Printed boards and printed board assemblies – Design and use – Part 5-2: Attachment (land/joint) considerations – Discrete components*

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IEC 61190-1-2:2014, *Attachment materials for electronic assembly – Part 1-2: Requirements for soldering pastes for high-quality interconnections in electronics assembly*

IEC 61190-1-3, *Attachment materials for electronic assembly – Part 1-3: Requirements for electronic grade solder alloys and fluxed and non-fluxed solid solder for electronic soldering applications*

IEC 62211:2017, *Inductive components – Reliability management*

koniec náhľadu – text ďalej pokračuje v platenej verzii STN